

American Opto Plus LED Corp. L933-SP275-2-30 3.5 x 3.5 x 1.6mm UVC SMD LED

PACKAGE OUTLINES



Notes:

- 1. All dimensions are in millimeters.
- 2. Tolerances are ±0.1mm unless otherwise noted.



3.5 x 3.5 x 1.6mm UVC SMD LED

ABSOLUTE MAXIMUM RATINGS			(Ta=25°C)
Parameter	Symbol	Value	Unit
Forward Current	lf	60	mA
LED Junction Temperature	Tj	90	°C
Thermal resistance	Rth	55	°C/W
Operating Temperature Range	Тор	-30 ~ +60	°C
Soldering Temperature	Тр	260°C for 5sec Max	

ELECTRO-OPTICAL CHARACTERISTICS

Devemeter	Test Condition	Symbol	Value			Unit
Parameter			Min	Тур	Мах	Unit
Peak Wavelength		λP	270	275	280	nm
Forward Voltage		Vf	5		7.5	V
Radiant Output	lf=30mA	Popt	2	3		mW
Spectral Half bandwidth		$ riangle \lambda$		9		nm
Viewing Angle at 50% lv		2 0 1/2		120		Deg

Note:

- 1. The tolerance of forward voltage is ± 0.1 V.
- The tolerance of radiant output is <u>+8%</u>.
 The tolerance of peak wavelength is <u>+</u>3nm.

(Ta=25°C)



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OPTICAL CHARACTERISTIC CURVES

Fig.1 Relative Radiant Power VS Forward Current(Ta=25°C) Fig.2 Forward Current VS Forward Voltage (Ta=25°C)



Forward Current (mA)



Fig.3 Forward Voltage VS Ambient Temperature



Fig.4 Relative Radiant Power VS Ambient Temperature





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Fig.5 Peak Wavelength VS Forward Current

Fig.6 Forward Current VS Ambient Temperature



Fig.7 Relative Intensity VS WLP



Fig.8 Radiation pattern@30mA





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RELIABILITY TEST

Test Item	Test Conditions	Note	Failure Criteria
Life Test	T _a =25°C I _F =60mA	1000 hrs	
High Temperature Storage	T _a =100°C	1000 hrs	Forward Voltage VF>120%
Low Temperature Storage	T _a =-40°C	1000 hrs	Radiant Output Popt<70%
Temperature Cycle	-40°C 30min ↑↓ 25°C 5min ↑↓ 100°C 30min	100 cycle	



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TAPE DEMINSION





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REEL DEMINSION







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REFLOW SOLIDERING PROFILE

Reflow Temp/time



Stage	Parameter	Symbol	Value	Unit
Preheat	Ramp-up Rate	TSmax to Tp	1	°C/sec
	Min. Temperature	TSmin	100-150	°C
	Max. Temperature	TSmax	180-200	С°
	Time	TSmin to TSmax	60-120	Sec
Equilibrium	Temperature	TL	217	°C
	Temperature Time	tL	50-80	Sec
Reflow Peak Tempo	Peak Temperature	Тр	260	°C
	Time	tr	20-40	Sec
Cooling	Ramp-down Rate	Vc	3	°C/sec
Preheat to Reflow	From 25°C to peak temperature	25°C to Tp	4 mins MAX.	



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PRECAUTIONS FOR USE:

Storage time:

- 1. Calculated shelf life before opening is 6 months at 10-30°C and < 60% relative humidity (RH).
- 2. After bag is opened, devices which will be subjected to reflow soldering or other high temperature processes must be:
 - a) Assembled within 24 hour, or
 - b) Stored at Moisture Proof bag with desiccant.
- 3. Devices are required baking before assembly if:
 - a) Package is opened before.
 - b) 2.a) or 2.b) doesn't meet.
- 4. If baking is required, devices should be baked for 6 hours at 60°C.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or antielectrostatic glove is recommended when handling these LED. All devices, equipment and machinery must be properly grounded.

Cleaning

In case where a minimal level of dirt and dust particles cannot be guaranteed, a suitable cleaning solution can be applied to the lens surface.

- Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED.
- Try a gentle swabbing with lint-free swab.
- If need, the use of tint-free swab and isopropyl alcohol used gently removes dirt from the lens.
- Don't use other solvents as they may directly react with the LED assembly.
- Don't use ultrasonic cleaning that the LED will be damaged.

Over-Current-Proof

Customer must apply resistors for protection; otherwise slight voltage shift will cause big current change (Burn out will happen).